

Interscale Mounting Bracket for 70 mm Flexible Heat Conductor (FHC), AMD CPU

CATALOG NUMBER

24830-003



The mounting bracket enables a user to assemble an Intel or AMD processor.

CERTIFICATIONS



FEATURES

Designed for ATX/ITX/Mini ITX & COM using Intel core-i processors and AMD processors with the following sockets: Intel: LGA775, LGA1150, LGA1155, LGA1156, LGA1366, LGA2011 ; AMD: AM2, AM2(+), AM3, AM3(+), FM1, FM2, FM2(+)

Utilizes keep out zones to not interfere with other board components

Designed to assemble the 70 mm Flexible Heat Conductor to the CPU

PRODUCT ATTRIBUTES

Design Feature: AMD CPU

Package Quantity: 1

Finish: Aluminum-Zinc Plated

Material: Steel

Product Family: Interscale

Product Type: Bracket

Type: CPU Adpater

Works With: Cases

Net Weight: 0.078kg

WARNING

nVent products shall be installed and used only as indicated in nVent's product instruction sheets and training materials. Instruction sheets are available at www.nvent.com and from your nVent customer service representative. Improper installation, misuse, misapplication or other failure to completely follow nVent's instructions and warnings may cause product malfunction, property damage, serious bodily injury and death and/or void your warranty.

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